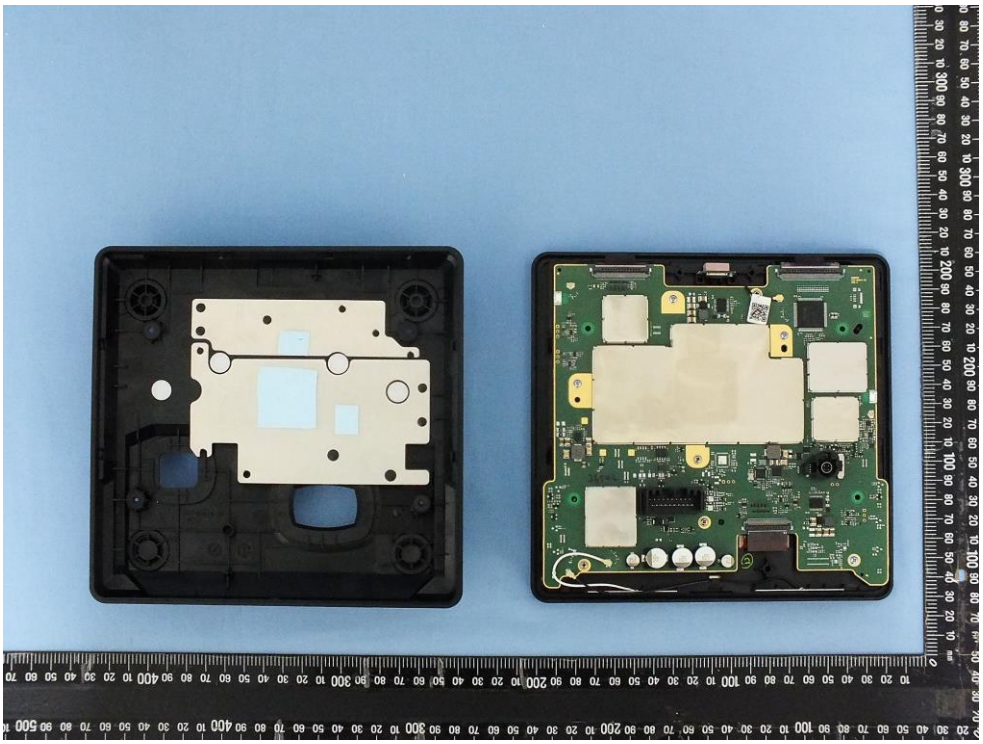

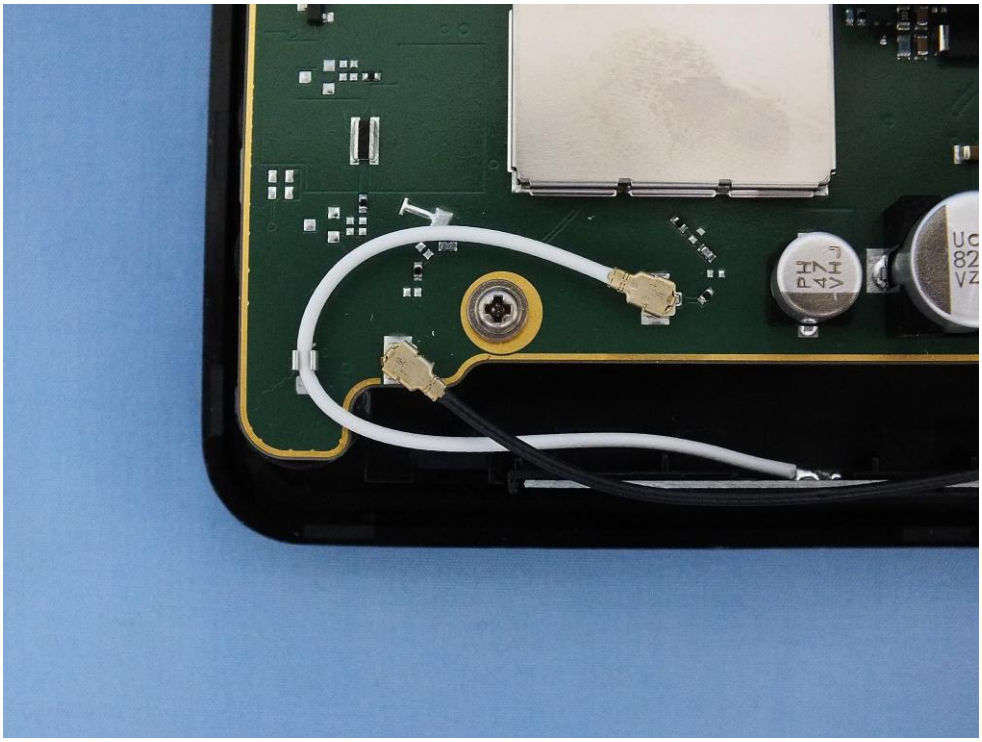

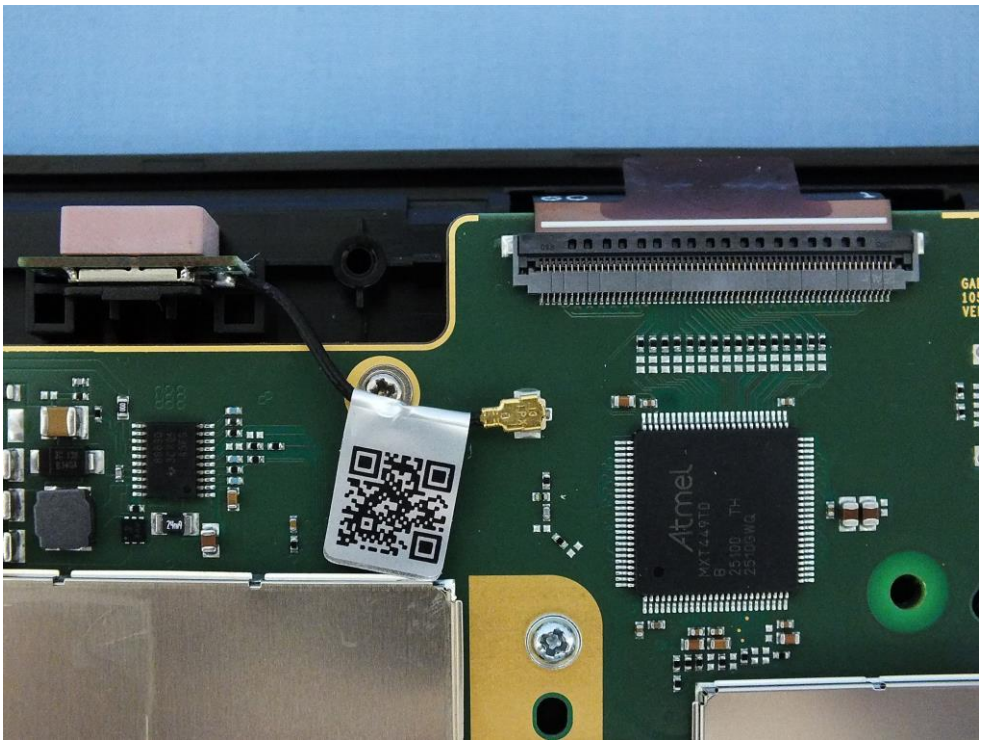
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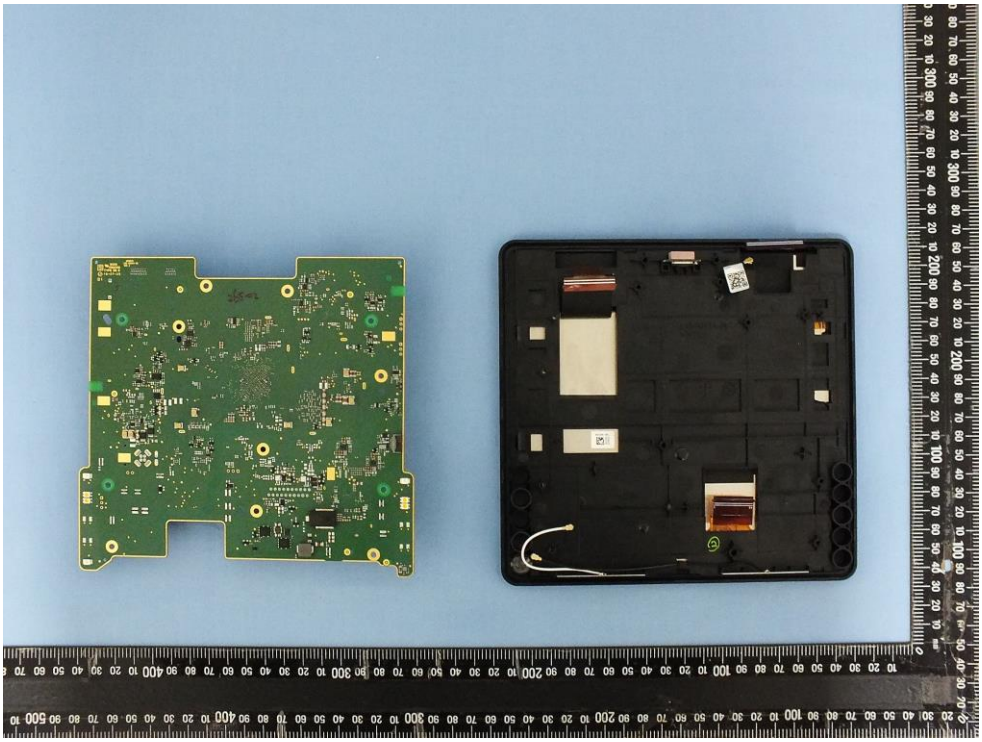

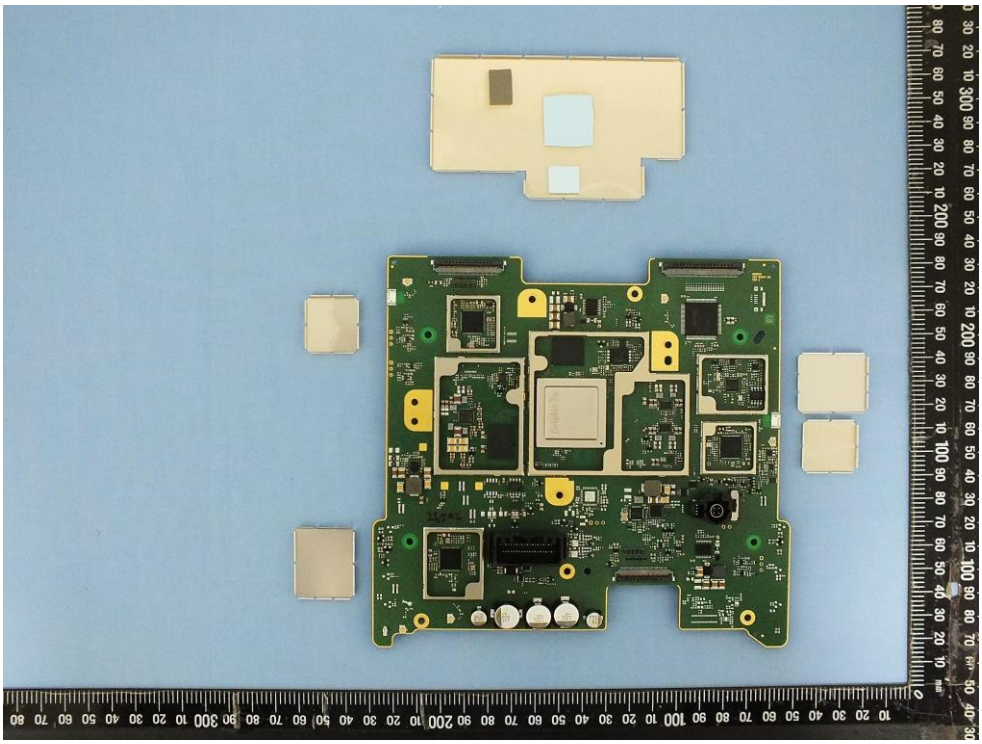

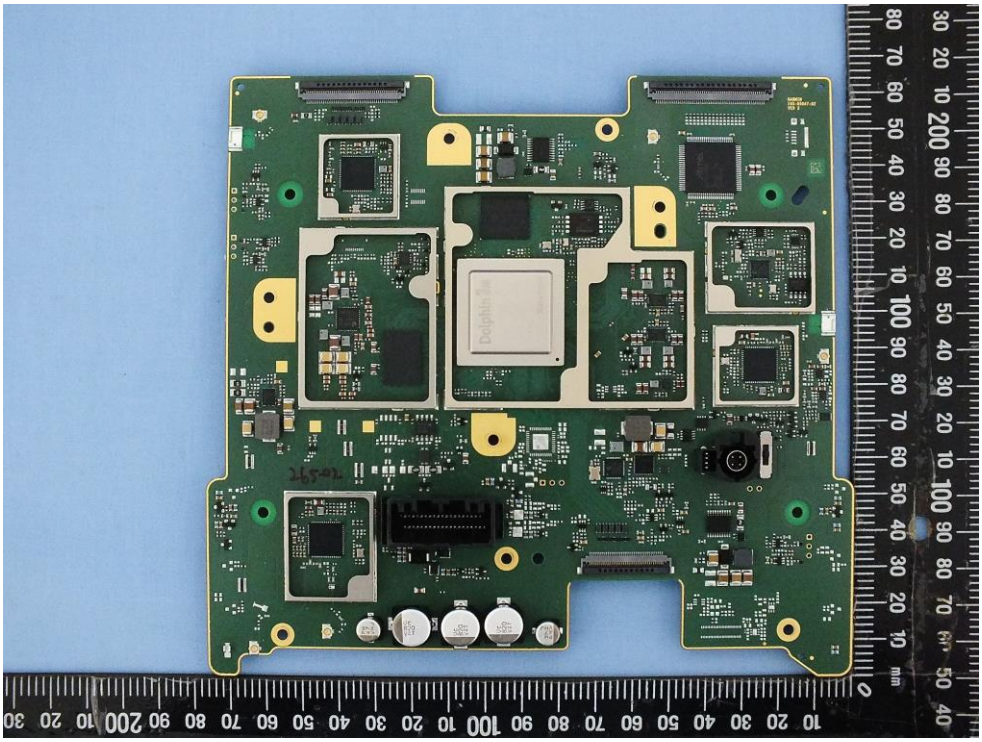

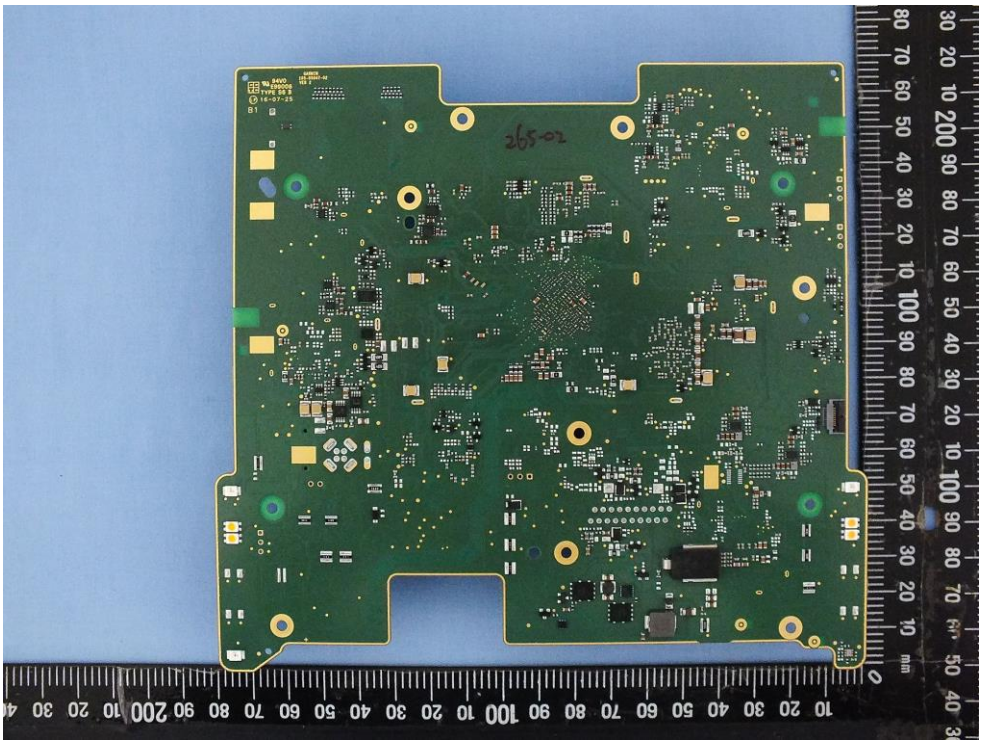

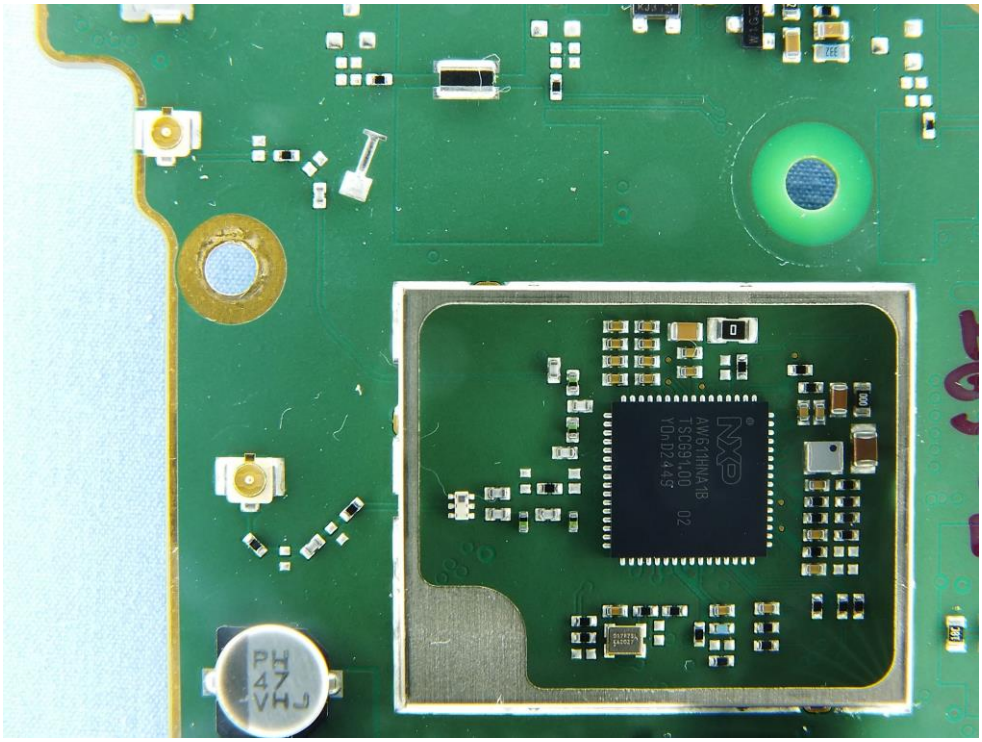
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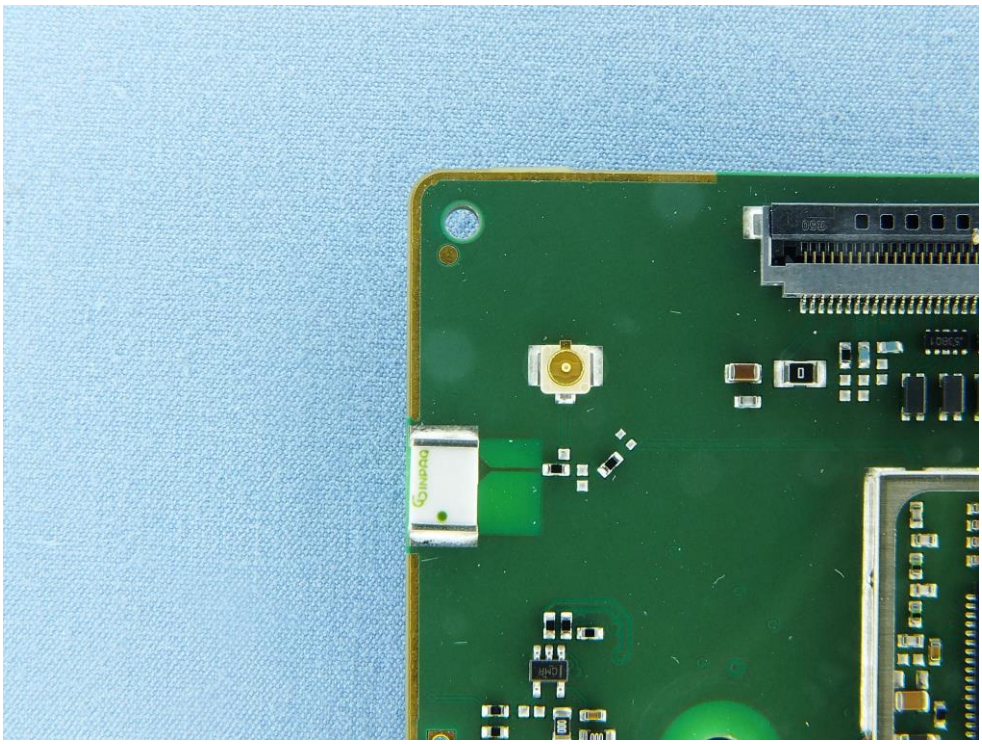

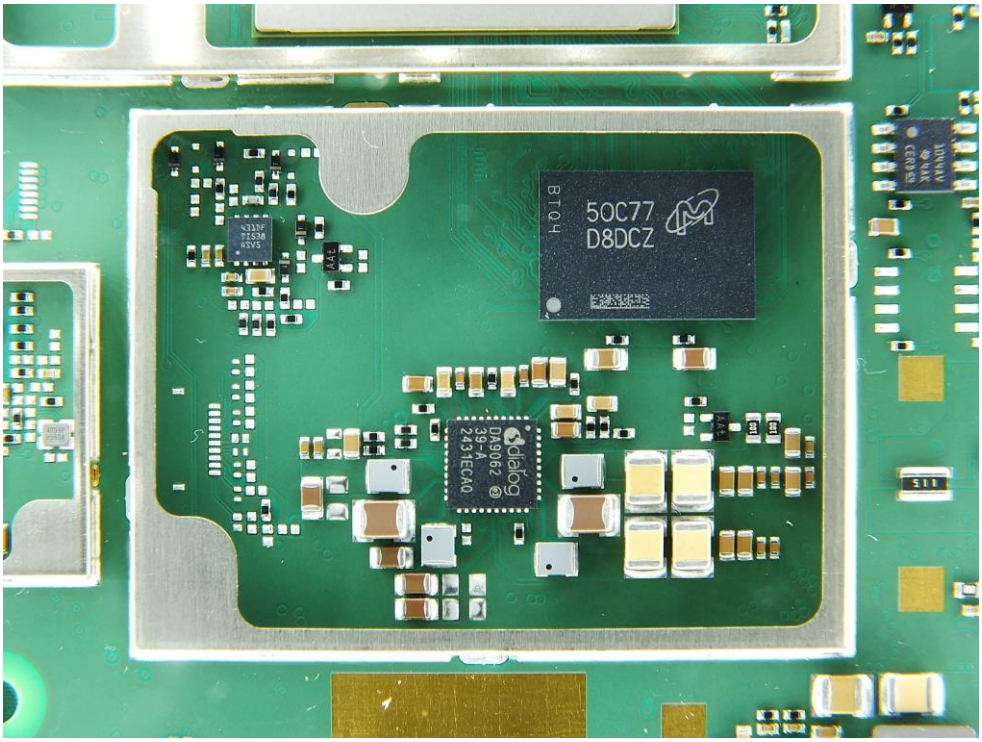
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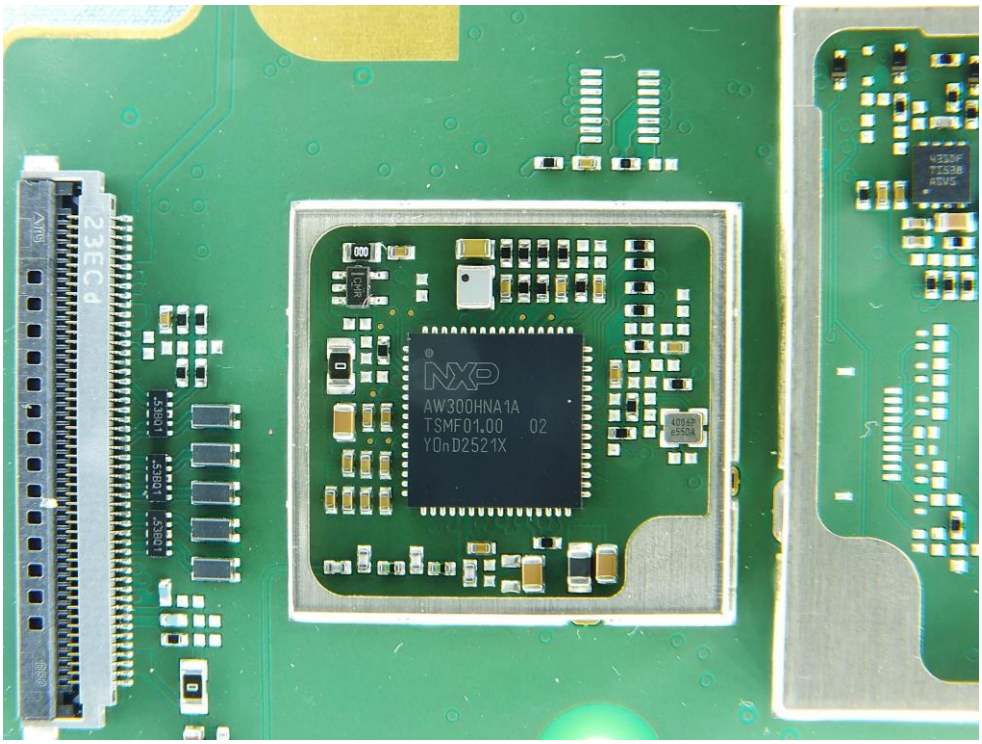
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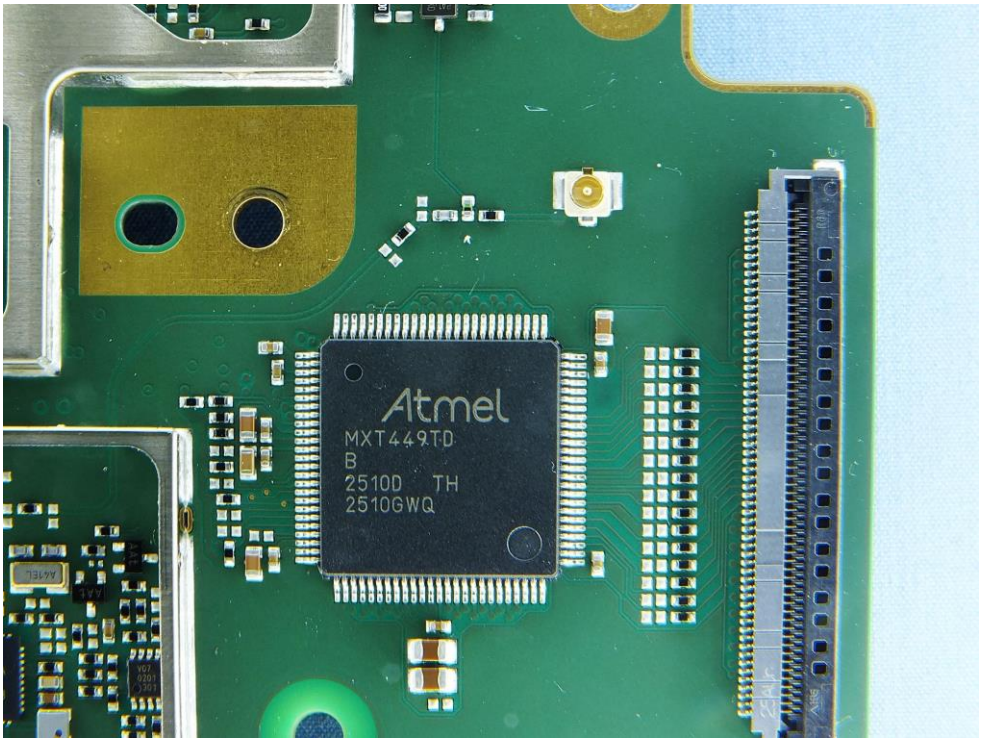
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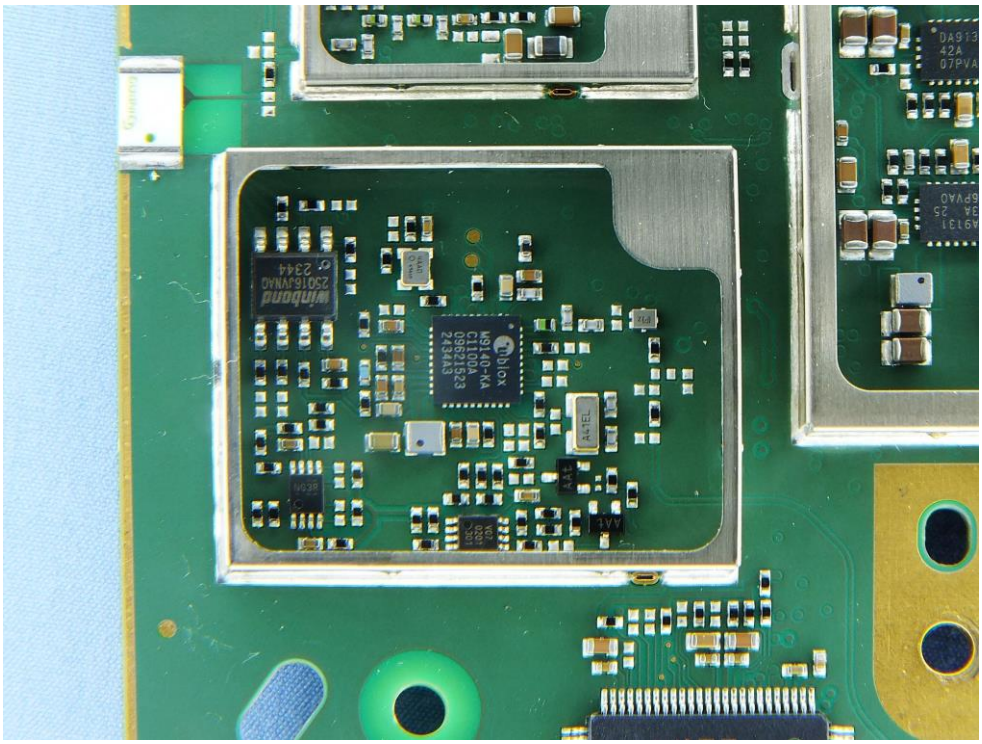
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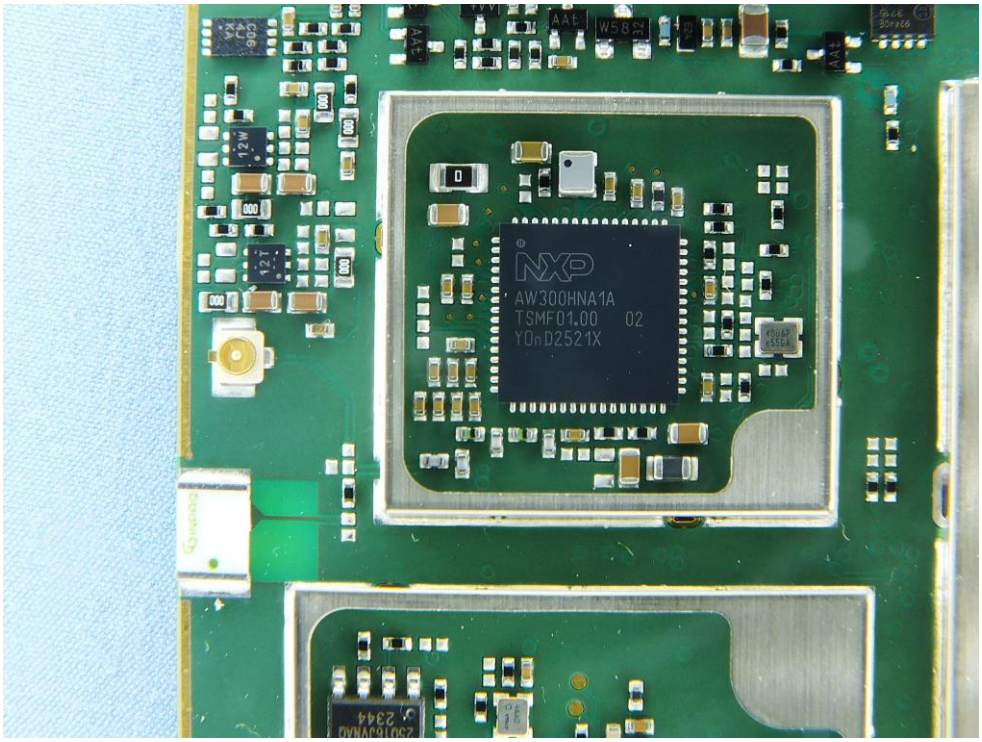
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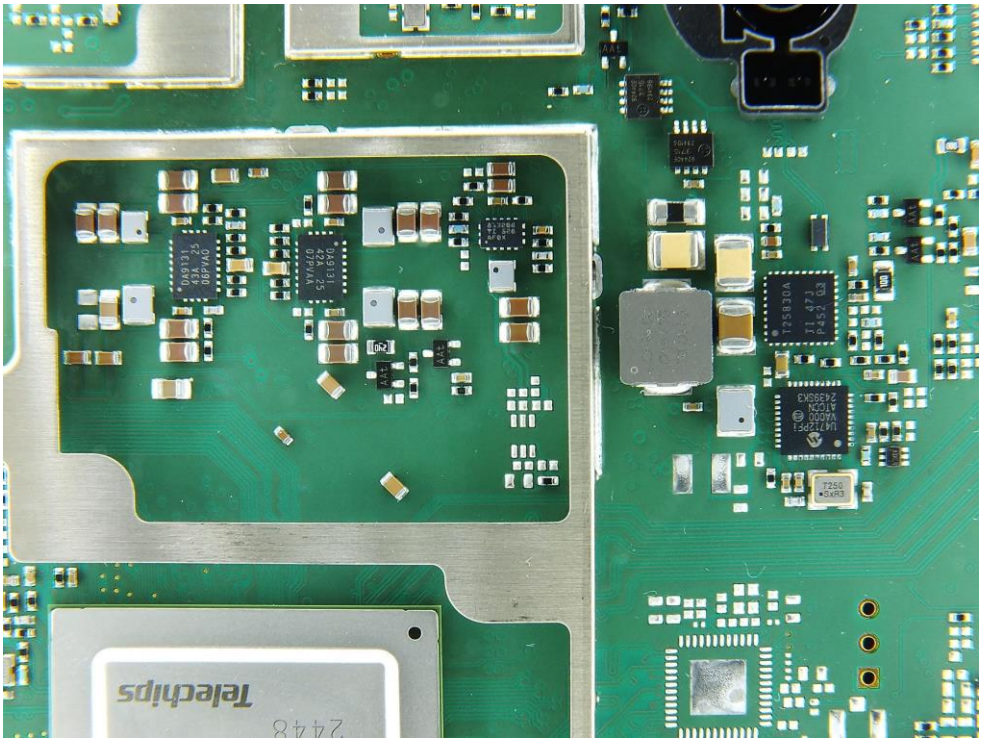
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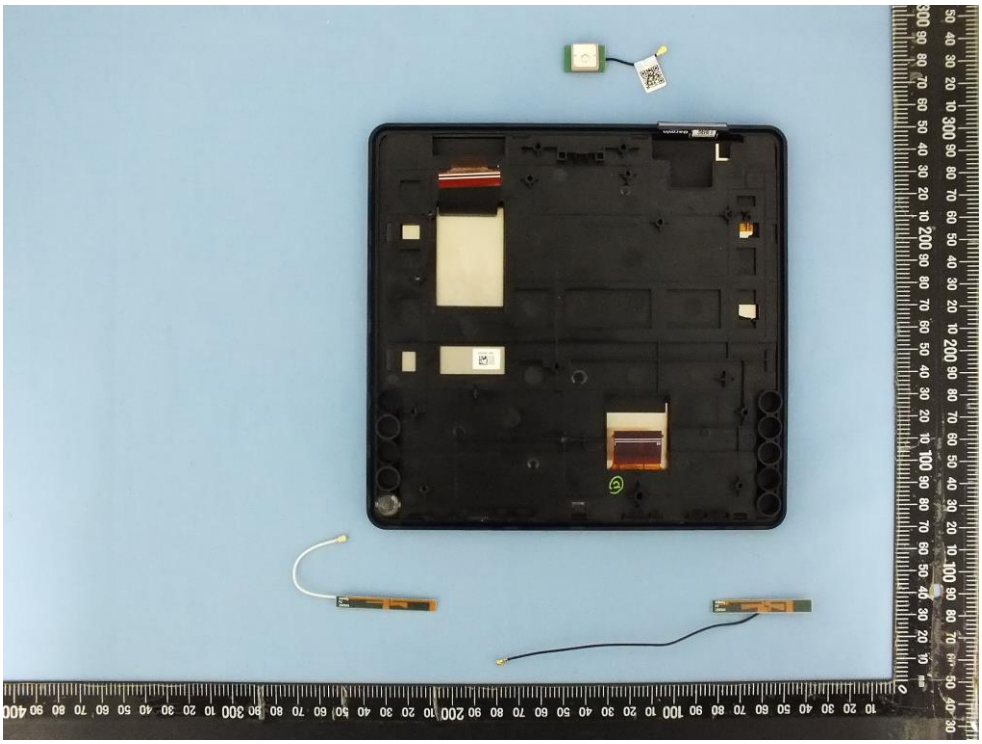

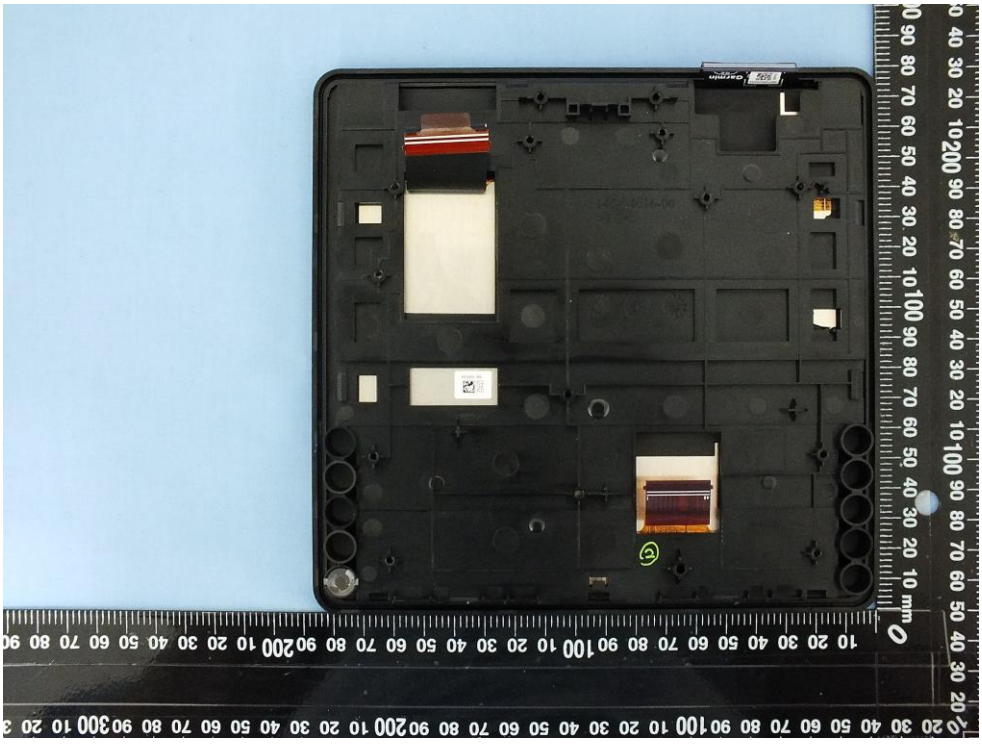

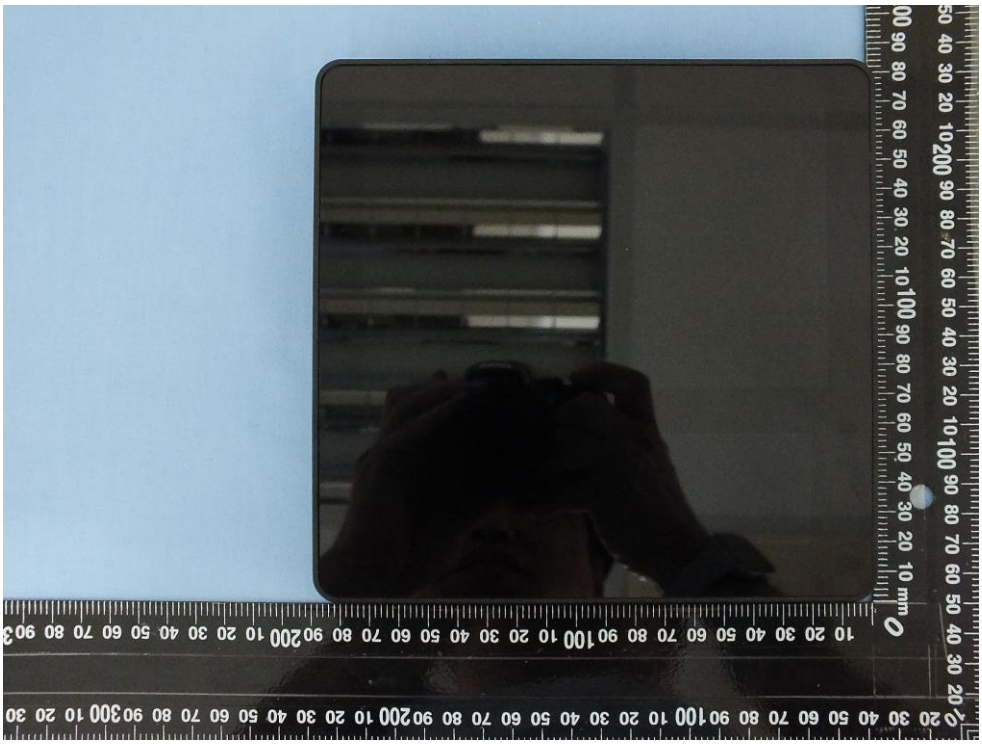

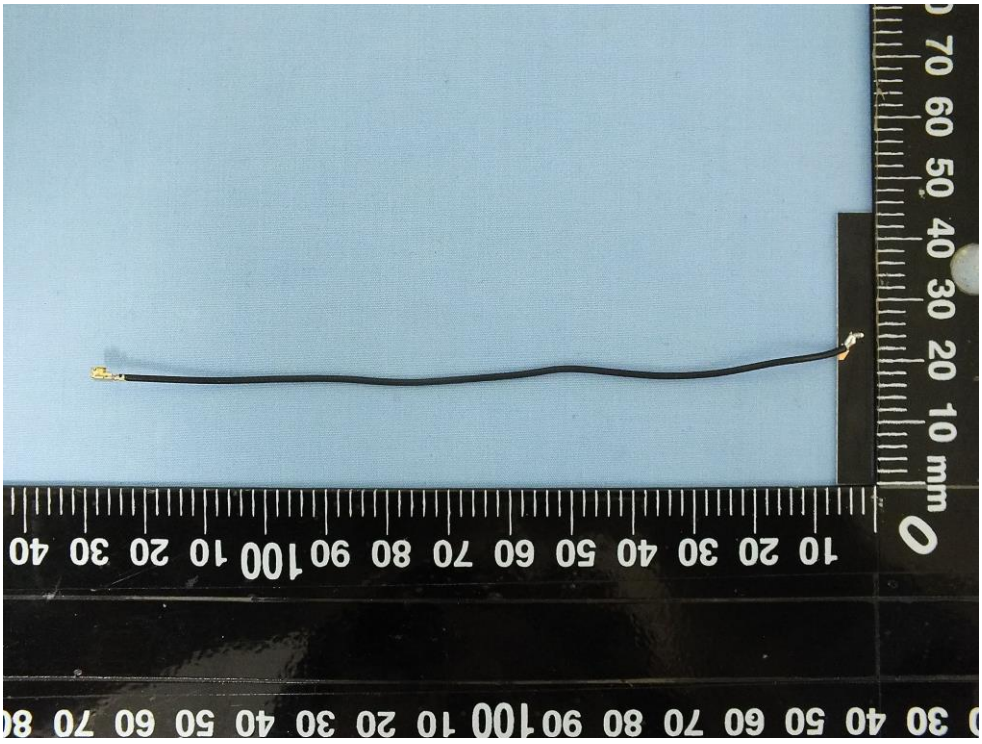

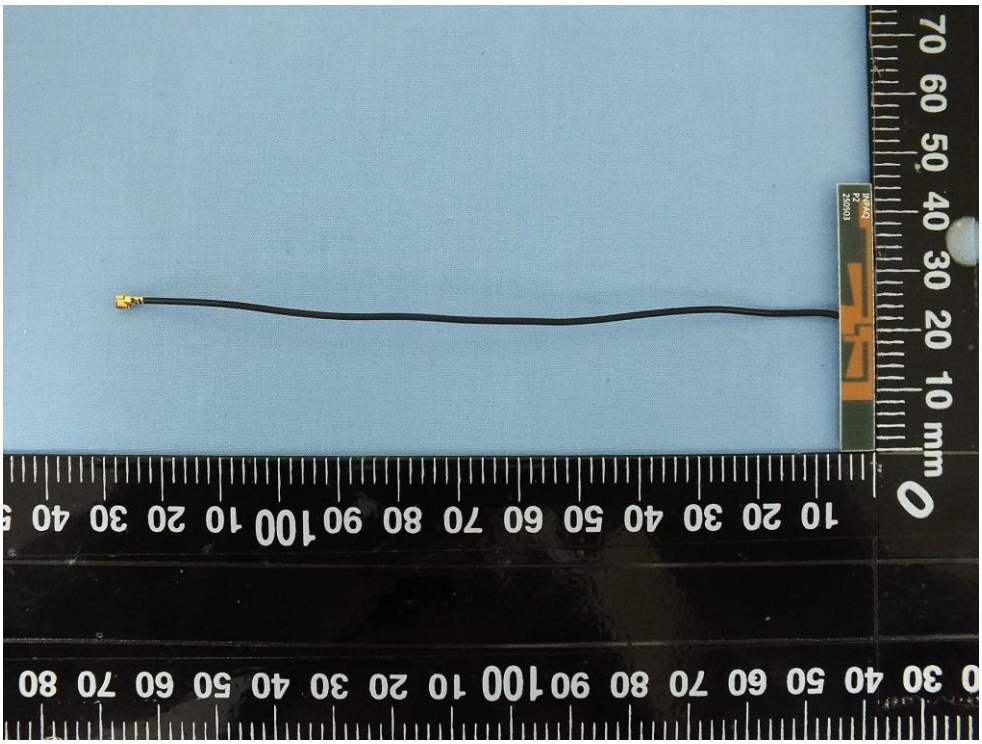

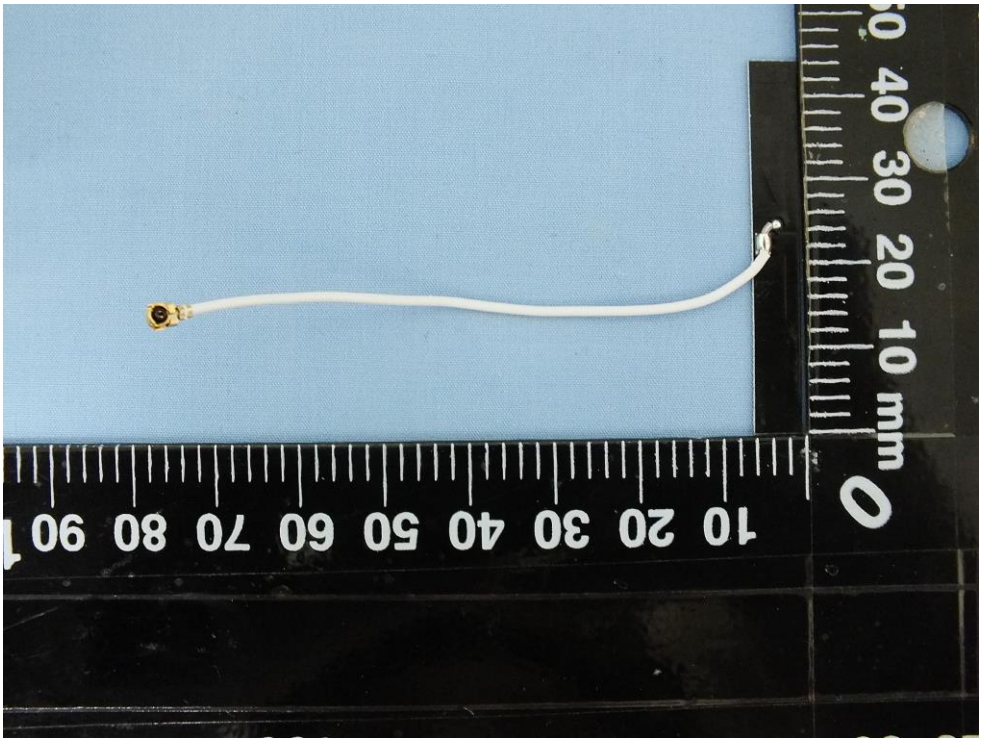

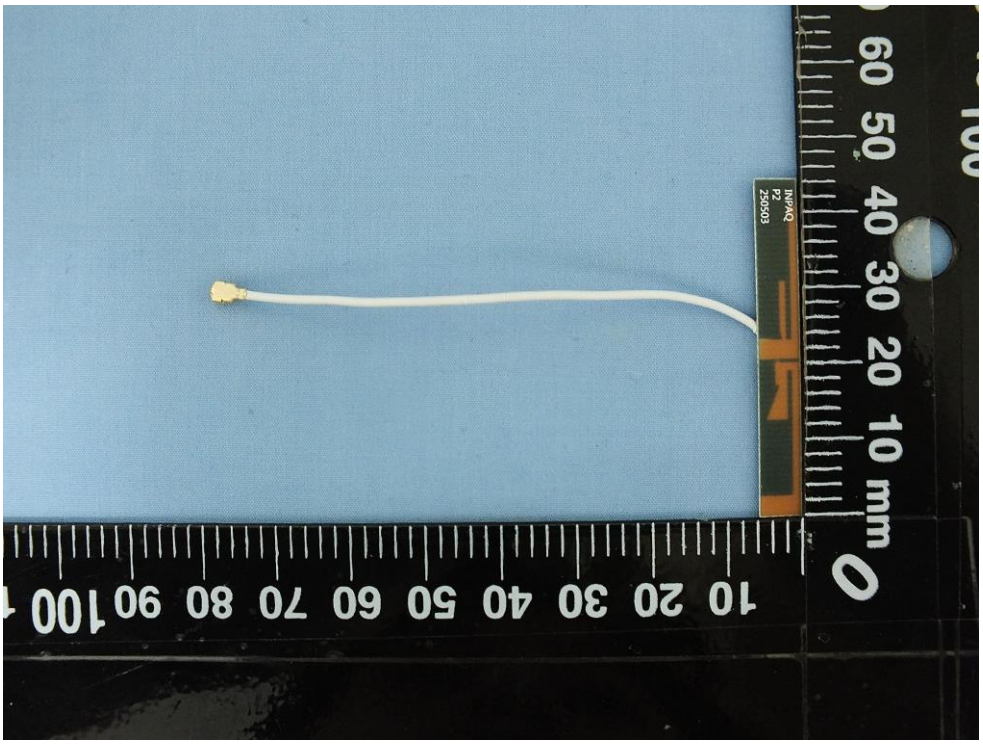

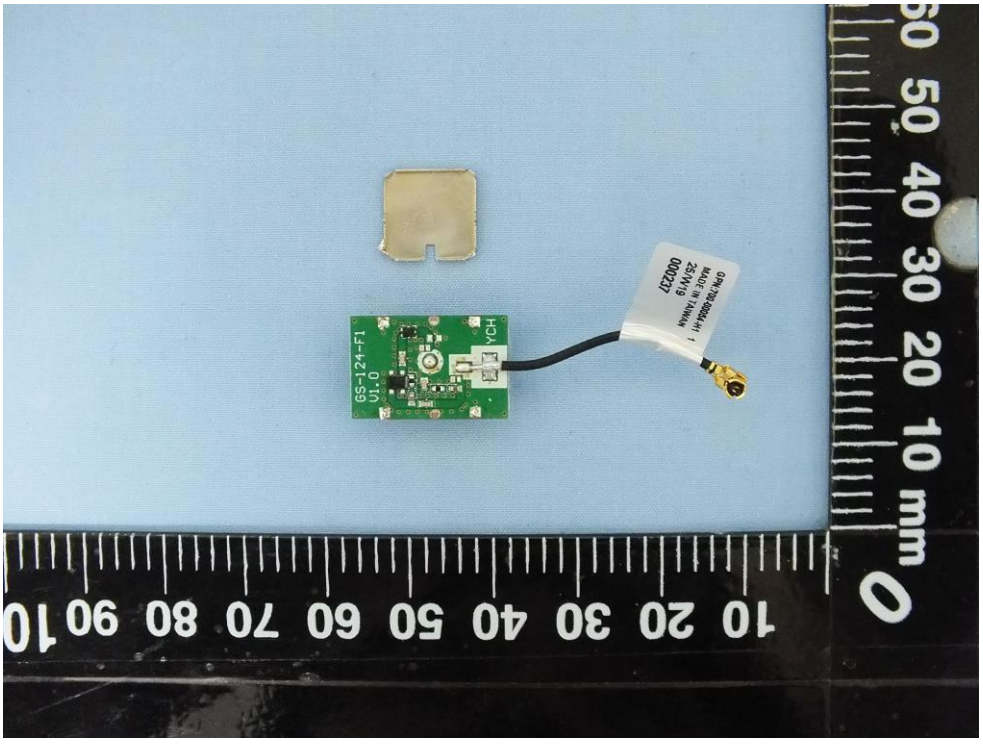

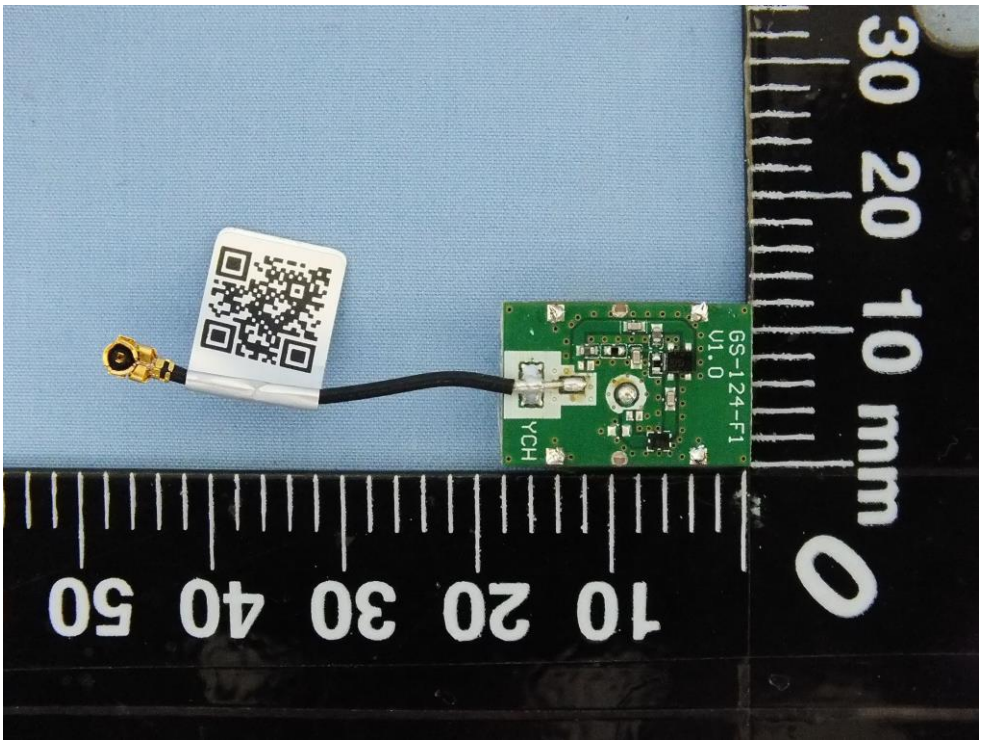
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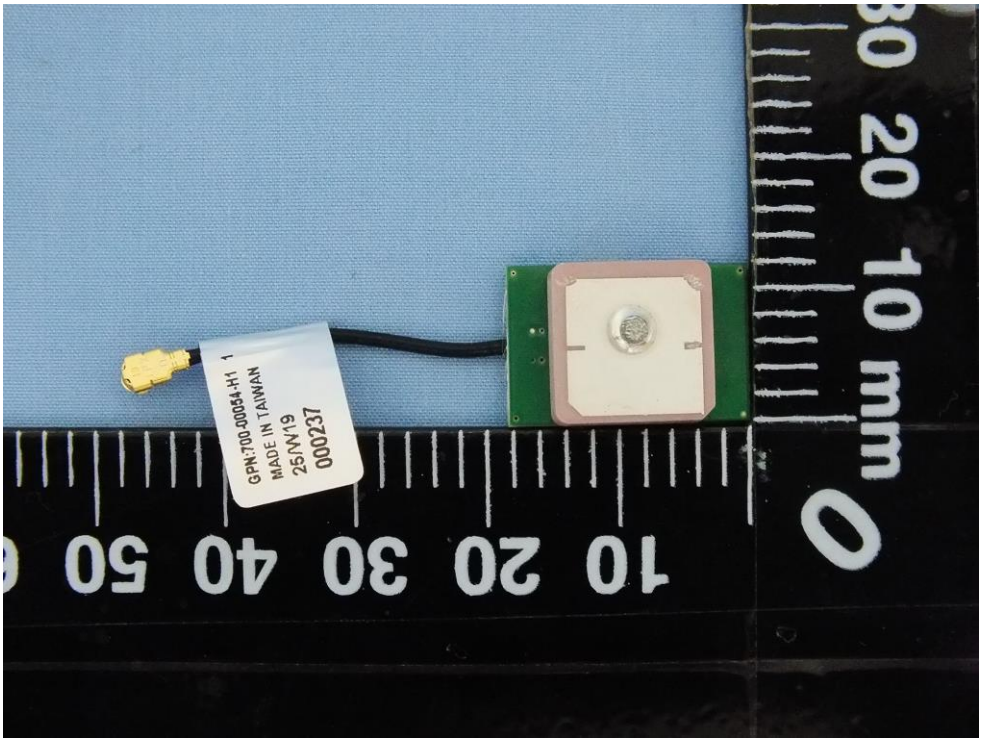
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MADE IN TAIWAN
25/VV19
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Protected Method	Description
Glue Case	RF and Modulation components are covered within case of EUT and this case used Glue to protect anybody to open this case. Then use the glue to compress tightly and protect the outer cover is not opened easily. The glue will be damaged and calibration function will be broken that causes measured value will be incorrect if the cover was opened.

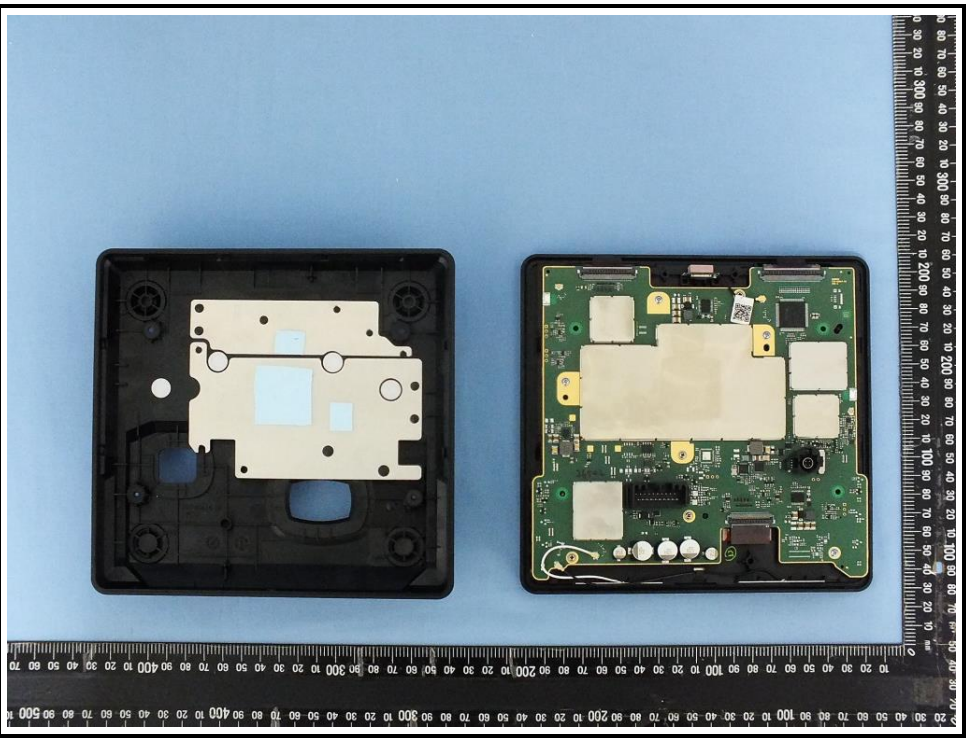
Photo-1	

Photo-2	
Photo-3	